

## 深圳市佑驰电子有限公司

### Specification for Approval

产品名称:	一体系列电感
规格型号:	HCMC-0640-XXX-M02
产品编号:	
日 期:	2020-03-16

- 1、本承认书的内容更改需经过双方确认,任一方单独的修改均视为无效。
- 2、本承认书在送达客户后,请给予承认并即签回, 如无签 回下订单 的, 我司有权以此 承认 书标准生产, 并表示购买方默认许可。

审核	制作

批准	申核	检验



	REVISION						
REV	DESCRIPTION	DATE	DESIGNED	CHECKED	APPROVED		
A0	文件建立	2020/03/16	吕秀秀	Bowen	Darren		



# High Current, Power Inductors HCMC-0640-XXX-M02 Power Choke





#### **Description**

- Halogen Free
- 125°C maximum total temperature operation
- 7.4x6.8x 4.0mm maximum surface mount package
- · Powder iron core material
- · Magnetically shielded, low EMI
- High current carrying capacity, Low core losses
- · RoHS compliant

#### **Applications**

- Voltage Regulator Module (VRM)
- · Multi-phase regulators
- · Point-of-load modules
- · Smart phone POL modules
- SSD modules
- · Notebook regulators
- Battery power systems
- · Graphics cards
- Data networking and storage systems

#### **Environmental Data**

- •Storage temperature range: -55°C to +125 °C
- •Operating temperature range: -55°C to +125°C (ambient plus self-temperature rise)
- •Solder reflow temperature: J-STD-020 compliant

Description												
	HCMC-0640-1R0-M02			1.0µH					±20 %			
			I	Model		Inductance Value			<b>:</b>		Inductance Tolerance	
					Global Part Number							
Н	С	M	С	0	6	4	0		1	R	0	M02
Product Series Dimens		nsions			Induc	tance V	/alue	Tolerance				



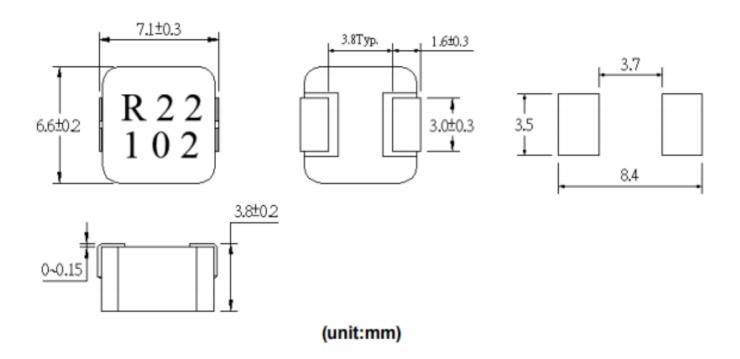
	Inductance	DC Resistance		DC Resistance Heating Rating Current	
Part No.	L0 (µH)	DCR $(m\Omega)$		Idc (A)	Isat (A)
	±20 %, 100 kHz, 1V	TYP.	MAX.	TYP.	TYP.
HCMC-0640-R22-M02	0.22	0.95	1.0	32.0	50.0
HCMC-0640-R36-M02	0.36	1.25	1.44	27.0	35.0

#### **Notes**

- 1. All test data is referenced to 25 °C ambient
- 2. Operating temperature range 55 °C to + 125 °C
- 3. Idc(A):DC current (A) that will cause an approximate ΔT of 40 °C(reference ambient temperature is 25 °C)
- 4. Isat(A):DC current (A) that will cause L0 to drop approximately 30 %
- 5. The part temperature (ambient + temp rise) should not exceed 125 °C under worst case operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.



#### •Dimensions-mm

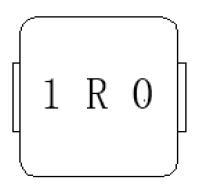


#### Marking

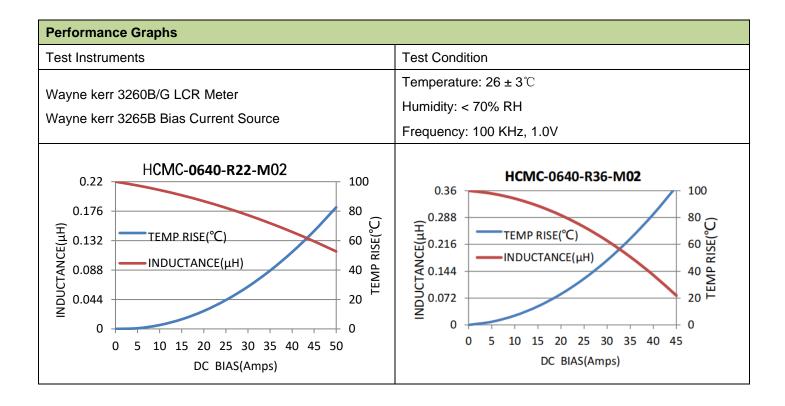
The inductor is marked with a 3-digit code

Example - -1.0→1R0

Note: Using Ink for marking



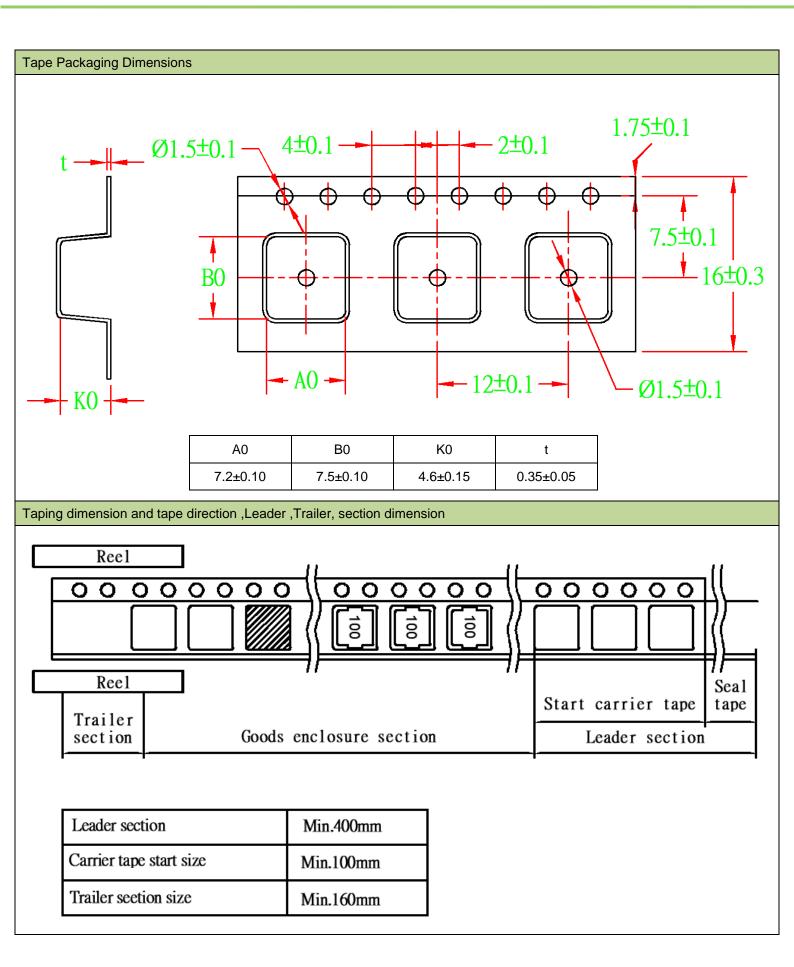




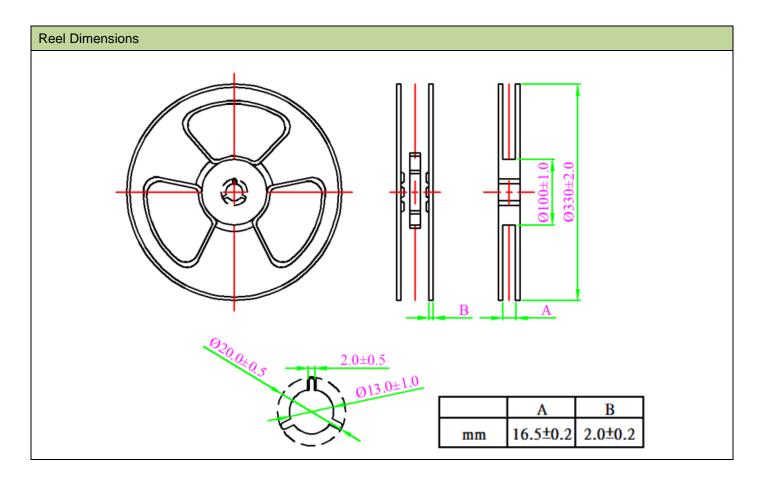


Mecha	anical Reliability			
No.	Item	Specification and Requirement	Test Method	
1	Solderability	The surface of terminal immersed shall be minimum of 95% covered with a new coating of solder	Retention time: 245 $\pm$ 5 $^{\circ}$ C for 5+0/-0.5seconds;	
2	Resistance to Soldering Heat	Change from an initial value Inductance:within ± 10%	Retention time: within 30 seconds 255 $\pm5$ $^{\circ}\mathrm{C}$ , Three Times;	
3	Terminal Strength	No electrode detachment	No electrode detachment should be found when the device is pushed is two directions of X and Y with the force of 17.7N for 60 seconds after soldering between copper plate and the electrodes;	
4	Vibration	Inductance change: Within ± 10% Without mechanical damage such as break	<ol> <li>Vibration frequency: (10 Hz to 2000 Hz to 10Hz) in 20 minutes as a period;</li> <li>Vibration time: Period cycled for four hours in each of 3 mutual perpendicular directions.</li> <li>Amplitude: 1.5 mm max.</li> </ol>	
5	Mechanical Shock	Inductance change: Within ± 10% Without mechanical damage such as break	Peak value: 100 G, Duration of pulse: 6ms     3 times in each positive and negative direction of 3 mutual perpendicular directions;	
6	Substrate Bending	Inductance change: Within ± 10% Without distinct damage in appearance	1.Bending speed is 0.5mm/sec, 2.While the bending width reaches 2mm, keep it for 60 sec	
Endur	ance Reliability			
No.	Item	Specification and Requirement	Test Method	
7	Thermal Shock	Inductance change: Within ± 10% Without distinct damage in appearance	Repeat 1000 cycles as follow: (-55 $\pm$ 2 $^{\circ}$ C; 30 $\pm$ 3 min) $\rightarrow$ (+125 $^{\circ}$ C $\pm$ 2 $^{\circ}$ C , 30 $\pm$ 3 min)	
8	Low Temperature Storage  Inductance change: Within ± 10%  Without distinct damage in appearance		Store temperature: -55 $\pm$ 2 $^{\circ}$ C, 1000 + 4 / -0 hours;	
9	High Temperature Storage	Inductance change: Within ± 10% Without distinct damage in appearance	Store temperature: $+125^{\circ}\text{C} \pm 2^{\circ}\text{C}$ , $1000 + 4 \text{ / } -0$ hours;	
10	High Temperature &Humidity	Inductance change: Within ± 10% Without distinct damage in appearance	85℃85%RH ,1000+4/-0 hours;	





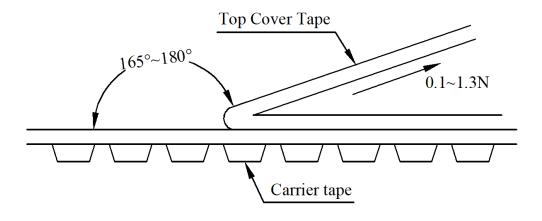




• Peel force of top cover tape

The peel speed shall be about 300mm/minute

The peel force of top cover tape shall be between 0.1 to 1.3 N



Numbers of taping
 1000pieces/reel